







2019 IEEE International Conference on Advanced Robotics and Mechatronics (ICARM 2019)

Prof. Weiwei Wan General Chair of ICARM 2019 Machikaneyamacho 1-3, Osaka University Toyonaka Campus, Toyonaka, Osaka, Japan Email: wan@sys.es.osaka-u.ac.jp

March 1, 2019 Dear Sir/Madam,

We would like to invite Mr. Shi Yapeng from Harbin Institute of Technology, China, to attend 2019 IEEE International Conference on Advanced Robotics and Mechatronics (ICARM 2019), which will be held in July 3-5, 2019, Japan.

The ICARM 2019 serves as a platform for scientists, researchers, and practitioners to discuss their forefront research results and findings, to shape their future directions and development, and to exchange their knowledge and perspectives in the field of robotics, intelligent control, automation science, engineering, and integration into the industry and society. It constitutes the primary forum for cross-industry, multidisciplinary research, and provides an opportunity to have a unique and rich cultural experience with excellent technical and social programs. The conference welcomes original, peer reviewed papers submissions in all areas related to intelligent areas, control systems, and automation science, especially innovative ideas, novel concepts, new discoveries and distinguished applications.

For more and most update information, please visit http://www.ieee-arm.org. Thank you with kind regards,

Prof. Weiwei Wan

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